### LATEST NEWS



#### **ESCC QPL January 2018 NEW FORMAT**

The ESCC QPL January was published with 3 extensions, 1 new certificate and 1 amendment.

Radiall is now qualified for the supply of of Connectors, RF, Coaxial, Very High Power, 50 OHMs, Based on Type TNC-VHP.



## **ESCC QML January 2018**

The ESCC QML issue 16 was published in January 2018 to include: Addition of Process Capability Approval of 3D PLUS (France)



### **NEW ESCC Process Capability Approval**

3D Plus is now certified in accordance with ESCC 2566001 for its 3D Staking Technology Modules!!



## **NEW ESCC Specifications Published:**

October 2017: A NEW ESCC Basic Specification REQUIREMENTS FOR THE PROCESS CAPABILITY APPROVAL FOR MANUFACTURING LINES OF NON-HERMETIC MICROELECTRONIC MODULES was published, ESCC **2566001 issue 1**. Please click HERE for more information



## ECSS-Q-ST-70-38rev1 (15 September 2017) Published

This Standard prescribes requirements for electrical connections of leadless and leaded surface mounted devices (SMD) on spacecraft and associated equipment, utilising a range of substrate assemblies and employing solder as the interconnection media. Please click HERE to view the document



### **Successfully completed ESCC Qualification AUDITS**

The ESCC Executive performs an audit of the manufacturer's design, production and test facilities. This combines a Quality Management System audit and a manufacturing line survey.

Recently ESA successfully preformed audits during 2017 at the following Qualified Manufacturers:

**4 in the UK**: AVX Ltd., TE Connectivity (Tyco Electronics Ltd.), W.L. Gore (UK), Teledyne Reynolds

**6 in France**: Atmel Microchip, Exxelia Magnetics (Microspire), Leach, Minco, Vishay Sfernice, 3D Plus

3 in Germany: Tesat, RHe Microsystems, Vishay Draloric

1 in Belgium: TAS

1 in Italy: IRCA-RICA

2 in Switzerland: IST, Diamond

## **UPCOMING EVENTS**



#### **Workshop on Innovative Technologies for Space Optics**

This workshop focuses on selected topics on innovative optical technologies identified as enabling for future missions or critical in the improvement of current mission concepts. 12-16 February 2018 at ESA/ESTEC in Noordwijk. For more information, please click HERE



### **NSREC 2018**

NSREC 2018 will take place in Kona, Hawaii from 16 - 20 of July 2018. For more information, please click <u>HERE</u>



### **Radecs 2018**

Radecs with take place in Gothenburg, Sweden from 16th to 21rst of September 2018. For more information, please click HERE

# RECENTLY PUBLISHED ESCC SPECIFICATION

**Up-Issued ESCC Specifications published since 15th December 2017** 

#### ACCESSORIES FOR CONNECTORS, MICROMINIATURE 3401/029, 3401/077 AND CONNECTOR SAVERS 3401/041

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